

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
GOODIX TECHNOLOGY INC.	07/15/2019
RECEIVING PARTY DATA	
Name:	SHENZHEN GOODIX TECHNOLOGY CO., LTD.
Street Address:	FLOOR 13, PHASE B, TENGFEI INDUSTRIAL BUILDING, FUTIAN TRADE ZONE
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518000
PROPERTY NUMBERS Total: 3	
Property Type	Number
Application Number:	16281105
Application Number:	16432916
Application Number:	16395222
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	LILY SUN
SIGNATURE:	/Lily Sun/
DATE SIGNED:	07/30/2019
Total Attachments: 1	
source=Assignment from Goodix Inc. to Goodix Shenzhen - Irvine - Bo Pi#page1.tif	

ASSIGNMENT

WHEREAS, Goodix Technology Inc., a corporation organized under the laws of United States ("ASSIGNOR"), located 6370 Lusk Blvd, Suite F204, San Diego, CA 92121, has an equal and undivided joint interest in and to the inventions ("Inventions") respectively described and set forth in the following application for United States Letters Patent ("Applications"):

U.S. Patent Application No. 16/281,105, Filed February 21, 2019;
U.S. Patent Application No. 16/432,916, Filed June 5, 2019; and
U.S. Patent Application No. 16/395,222, Filed April 25, 2019.

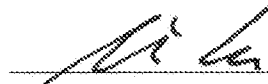
WHEREAS, Shenzhen Goodix Technology Co., Ltd., a corporation organized under the laws of China ("ASSIGNEE"), located Floor 13, Phase B, Tengfei Industrial Building, Futian Free Trade Zone, Shenzhen, Guangdong 518000, China, is desirous of acquiring an equal and undivided joint interest in the Inventions and Applications and in any U.S. Letters Patents and Registrations which may be granted on the same;

For good and valuable consideration, receipt of which is hereby acknowledged by ASSIGNOR, ASSIGNOR has assigned, and by these presents does assign to ASSIGNEE all right, title and interest in and to the Inventions and Applications and to all foreign counterparts (including patents, utility models and industrial designs), and in and to any Letters Patents and Registrations which may hereafter be granted on any patent applications claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the Applications as provided by the Paris Convention. The right, title and interest is to be jointly held and enjoyed by ASSIGNEE, and its respective successors and assigns, as fully as it would have been held and enjoyed by ASSIGNOR had this Assignment not been made, for the full term of any Letters Patents and Registrations which may be granted thereon, or of any divisions, renewals, continuations in whole or in part, substitutions, conversions, reissues, prolongation or extensions thereof.

ASSIGNOR further agrees that ASSIGNOR will, without charge to ASSIGNEE, but at ASSIGNEE'S expense, (a) cooperate with ASSIGNEE in the prosecution of any U.S. Patent applications and foreign counterparts on the Inventions and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including applications and instruments of transfer, and (c) perform such other acts as ASSIGNEE lawfully may request to obtain or maintain any Letters Patents and Registrations which may hereafter be granted on the Inventions and any improvements in any and all countries, and to vest joint title thereto in ASSIGNEE, or their respective successors and assigns.

IN TESTIMONY WHEREOF, representative of ASSIGNOR has signed his name on the date indicated.

Dated: 7/15/2019



PI, Bo
Chief Technology Officer
Goodix Technology Inc.